APPLICA	BLE STAN	IDARD									
Operating		\wedge	_55 °C +0 105 °C (1)			rage			-10 °C to 6		(2)
	Temperature Range 2		Signal Contact : 50 V AC			mperature Range			-10 °C to 60 °C (2) Relative humidity 85% max (Not dewed)		
Rating			Power Contact : 200 V AC Signal Contact : 0.5 A			orage Humidity Range					
	Current		Power Contact : 3.0A			perating Humidity Range					
	I		SPEC	IFICA	TION	S		L.			
IT	EM		TEST METHOD	11 10/1			RF(REMENTS	ОТ	АТ
			TEST WETTOD				INL	QUII	CLIVILIVIO	QΙ	ΙΛ1
CONSTRUCTION General Examination		Visually and by measuring instrument.				According to drawing.				×	×
Marking		Confirmed visually.				7100010	ing to ara	wiiig.		×	×
ELECTRIC CHARAC		•									1
Contact Resistance		100 mA(DC or 1000Hz)				Signal Contact : 70m Ω MAX.				×	_
Insulation Resistance Voltage Proof						Power Contact : 20m Ω MAX.					
		Signal Contact : 100 V DC.				Signal Contact : 100 MΩMIN.				×	_
		Power Contact : 250 V DC Signal Contact : 150 V AC for 1 min.				Power Contact : 1000 MΩMIN.					
		Power Contact : 600 V AC for 1 min.				No flashover or breakdown.					× -
MECHANI	CAL CHAR									×	1
Insertion and			by applicable connector.			Insertic	n Force:	1	8 N MAX.	×	Ι –
Withdrawal Forces						Withdrawal Force: 2 N MIN.					
Mechanical Operation		100 times insertions and extractions.				 Contact Resistance: Signal Contact: 80m Ω MAX. Power Contact: 30m Ω MAX. No damage, crack and looseness of parts. 				×	_
Vibration		Frequency 10 to 55 to 10Hz, approx 5min Single amplitude: 0.75 mm, 10 cycles for 3 axial directions.				 No electrical discontinuity of 1 μs. No damage, crack and looseness of parts. 				×	-
Shock		490 m/s ² , duration of pulse 11 ms								×	_
			for 3 both axial directions.								
ENVIRON	MENTAL C	CHARACT	ERISTICS								
Damp Heat		Exposed at 40±2 °C, 90 ~ 95 %, 96 h.				① Cor	ntact Resi	stance	э:	×	_
(Steady state)					Signal Contact : 80m Ω MAX. Power Contact : 30m Ω MAX. (② Insulation Resistance:						
Rapid Change of Temperature		Temperature $-55 \rightarrow +85 ^{\circ}\text{C}$ Time $30 \rightarrow 30 \text{ min.}$							×	_	
remperature	•	Time under 5		nin.		_	Bignal Cor				
		(Relocation time to chamber : within 2~3 MIN)				Power Contact : 1000 MΩ MIN. ③ No damage, crack and looseness of parts.					
Cold		Exposed at -55°C, 96 h			① Contact Resistance: Signal Contact: 80m Ω MAX.				×	-	
Dry Heat		Exposed at 105°C, 96 h			Power Contact: 30m Ω MAX. ② No damage, crack and looseness of parts.				×	-	
Sulfur Dioxide Resistance to		Exposed at 25±2°C, 75±5%RH, 25 PPM for 96 h. (Test standard: IEC 68) 1)Reflow soldering:				 No defect such as corrosion which impairs the function of connector. Contact Resistance: Signal Contact: 80m Ω MAX. Power Contact: 30m Ω MAX. No deformation of case of excessive 				×	_
										×	+_
Soldering Heat		Peak TMP : 260°CMAX Reflow TMP: 220°CMIN for 60sec			looseness of the terminal.						
Solderability			ng irons: 360°C MAX. for 5 at solder temperature	sec.		Δ ηρω	uniform o	natino	of solder shall cover a	×	+
Coldorability			40±3°C for immersion duration, 3 sec.			A new uniform coating of solder shall cover a minimum of 95 % of the surface being immersed.					
COUN			SCRIPTION OF REVISIONS DESI			GNED CHECKED				DA	TE
<u>^</u> 2 2			F-00002064	TS. 00		ONO			HT. YAMAGUCHI	17. 02. 02	
REMARKS (1) Include temper		ature rise caused by current-carrying.				APPROVED			HS. OKAWA	14. 07. 18 14. 07. 18 14. 07. 17	
(2) "STORAGE" means a long before assembly to PCB.			a long-term storage state for the unused product PCB.			CHECKED DESIGNED		ED	KN. SHIBUYA		
								IED	TS. 00N0		
Unless otherwise specified, refer			r to IEC 60512.			DRAWN		'N	TS. 00N0	14. 07. 17	
Note QT:Qualification Test AT:Assurance Te			urance Test X:Applicable Te	t X:Applicable Test		RAWING NO.			ELC-353552-00-00)
HS.		SPECIFICATION SHEET			PART NO.						
FORM HD0011-2-1		OSE ELECTRIC CO., LTD.			CODE	DE NO. CL573-			-3202-2-00	<u>/2\</u>	1/1